LM136-2.5

LM136-2.5 LM236-2.5 LM336-2.5V Reference Diode



Literature Number: SNVS749E



February 27, 2009

LM136-2.5/LM236-2.5/LM336-2.5V Reference Diode

LM136-2.5 LM236-2.5 LM336-2.5V

Reference Diode

General Description

The LM136-2.5/LM236-2.5 and LM336-2.5 integrated circuits are precision 2.5V shunt regulator diodes. These monolithic IC voltage references operate as a low-temperature-coefficient 2.5V zener with 0.2 Ω dynamic impedance. A third terminal on the LM136-2.5 allows the reference voltage and temperature coefficient to be trimmed easily.

The LM136-2.5 series is useful as a precision 2.5V low voltage reference for digital voltmeters, power supplies or op amp circuitry. The 2.5V make it convenient to obtain a stable reference from 5V logic supplies. Further, since the LM136-2.5 operates as a shunt regulator, it can be used as either a positive or negative voltage reference.

The LM136-2.5 is rated for operation over -55° C to $+125^{\circ}$ C while the LM236-2.5 is rated over a -25° C to $+85^{\circ}$ C temperature range.

The LM336-2.5 is rated for operation over a 0°C to +70°C temperature range. See the connection diagrams for available packages.

Features

- Low temperature coefficient
- Wide operating current of 400 µA to 10 mA
- 0.2Ω dynamic impedance
- ±1% initial tolerance available
- Guaranteed temperature stability
- Easily trimmed for minimum temperature drift
- Fast turn-on



LM136-2.5/LM236-2.5/LM336-2.5V

Typical Applications



[†]Adjust to 2.490V ^{*}Any silicon signal diode

Wide Input Range Reference



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Reverse Current	15 mA
Forward Current	10 mA
Storage Temperature	–60°C to +150°C
Operating Temperature Range (Note 2)	
LM136	–55°C to +150°C
LM236	–25°C to +85°C

Electrical Characteristics (Note 3)

LM336	0°C to +70°C	
Soldering Information		
TO-92 Package (10 sec.)	260°C	
TO-46 Package (10 sec.)	300°C	
SO Package		
Vapor Phase (60 sec.)	215°C	
Infrared (15 sec.)	220°C	
See AN 450 "Surface Mounting Methods and Their Effect		

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" (Appendix D) for other methods of soldering surface mount devices.

Parameter	Conditions	LM136A-2.5/LM236A-2.5 LM136-2.5/LM236-2.5			LM336B-2.5 LM336-2.5			Units
		Min	Тур	Max	Min	Тур	Max	
Reverse Breakdown Voltage	T _A =25°C, I _R =1 mA							
	LM136, LM236, LM336	2.440	2.490	2.540	2.390	2.490	2.590	V
	LM136A, LM236A, LM336B	2.465	2.490	2.515	2.440	2.490	2.540	V
Reverse Breakdown Change	T _A =25°C,		2.6	6		2.6	10	mV
With Current	400 µA≤I _R ≤10 mA							
Reverse Dynamic Impedance	T _A =25°C, I _R =1 mA, f = 100 Hz		0.2	0.6		0.2	1	Ω
Temperature Stability	V _R Adjusted to 2.490V							
(Note 4)	I _R =1 mA, <i>Figure 2</i>							
	0°C≤T _A ≤70°C (LM336)					1.8	6	mV
	–25°C≤T _A ≤+85°C (LM236H, LM236Z)		3.5	9				mV
	–25°C ≤ T _A ≤ +85°C (LM236M)		7.5	18				mV
	–55°C≤T _A ≤+125°C (LM136)		12	18				mV
Reverse Breakdown Change With Current	400 µA≤I _R ≤10 mA		3	10		3	12	mV
Reverse Dynamic Impedance	I _R =1 mA		0.4	1		0.4	1.4	Ω
Long Term Stability	$T_A = 25^{\circ}C \pm 0.1^{\circ}C$, $I_R = 1 \text{ mA}$, t = 1000 hrs		20			20		ppm

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its specified operating conditions.

Note 2: For elevated temperature operation, T_i max is:

LM136	150°C
LM236	125°C
LM336	100°C

Thermal Resistance	TO-92	TO-46	SO-8
θ_{ia} (Junction to Ambient)	180°C/W (0.4 leads)	440°C/W	165°C/W
,	170°C/W (0.125 lead)		
θ_{ja} (Junction to Case)	n/a	80°C/W	n/a

Note 3: Unless otherwise specified, the LM136-2.5 is specified from $-55^{\circ}C \le T_A \le +125^{\circ}C$, the LM236-2.5 from $-25^{\circ}C \le T_A \le +85^{\circ}C$ and the LM336-2.5 from $0^{\circ}C \le T_A \le +70^{\circ}C$.

Note 4: Temperature stability for the LM336 and LM236 family is guaranteed by design. Design limits are guaranteed (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels. Stability is defined as the maximum change in V_{ref} from 25°C to T_A (min) or T_A (max).

Typical Performance Characteristics







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Forward Characteristics



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Application Hints

The LM136 series voltage references are much easier to use than ordinary zener diodes. Their low impedance and wide operating current range simplify biasing in almost any circuit. Further, either the breakdown voltage or the temperature coefficient can be adjusted to optimize circuit performance.

Figure 1 shows an LM136 with a 10k potentiometer for adjusting the reverse breakdown voltage. With the addition of R1 the breakdown voltage can be adjusted without affecting the temperature coefficient of the device. The adjustment range is usually sufficient to adjust for both the initial device tolerance and inaccuracies in buffer circuitry.

If minimum temperature coefficient is desired, two diodes can be added in series with the adjustment potentiometer as shown in *Figure 2*. When the device is adjusted to 2.490V the temperature coefficient is minimized. Almost any silicon signal diode can be used for this purpose such as a 1N914, 1N4148 or a 1N457. For proper temperature compensation the diodes should be in the same thermal environment as the LM136. It is usually sufficient to mount the diodes near the LM136 on the printed circuit board. The absolute resistance of R1 is not critical and any value from 2k to 20k will work.







FIGURE 2. Temperature Coefficient Adjustment (Trim Range = ±70 mV typical)



Low Cost 2 Amp Switching Regulator⁺







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LM136-2.5/LM236-2.5/LM336-2.5V

LM136-2.5/LM236-2.5/LM336-2.5V



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ZOJA (Rev G)

Notes

Notes

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